MOSFET - Power, N-Channel, Shielded Gate, POWERTRENCH®
100 V, 50 A, 10.6 mΩ

NTTFS010N10MCL

General Description

This N−Channel POWETRENCH® MOSFET is produced using **onsemi**'s advanced POWERTRENCH® process that incorporates Shielded Gate technology. This process has been optimized to minimize on−state resistance and yet maintain superior switching performance with best in class soft body diode.

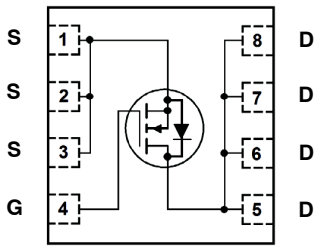
Features

- Shielded Gate MOSFET Technology
- Max $r_{DS(on)}$ = 10.6 mΩ at V_{GS} = 10 V, I_D = 15 A
- Max $r_{DS(on)}$ = 15.9 mΩ at V_{GS} = 4.5 V, I_D = 12 A
- 50% Lower Qrr than Other MOSFET Suppliers
- Lowers Switching Noise/EMI
- MSL1 Robust Package Design
- 100% UIL Tested
- RoHS Compliant

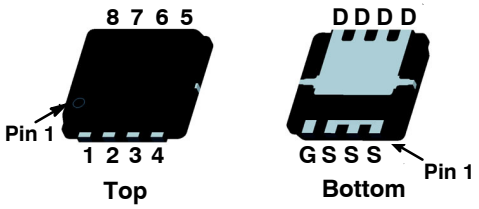
Applications

- Primary DC−DC MOSFET
- Synchronous Rectifier in DC−DC and AC−DC
- Motor Drive

ELECTRICAL CONNECTION



N-Channel MOSFET



WDFN8
(3.3x3.3, 0.65 P)
CASE 511DY

MARKING DIAGRAM



N10L	= Device Code
A	= Assembly Location
Y	= Year Code
WW	= Work Week Code

ORDERING INFORMATION

See detailed ordering and shipping information on page 2 of this data sheet.

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MOSFET MAXIMUM RATINGS (T_A = 25°C unless otherwise noted)

Symbol	Parameter				Ratings	Unit
V_{DS}	Drain to Source Voltage				100	V
V_{GS}	Gate to Source Voltage				±20	V
I_D	Drain Current	–Continuous	T_C = 25°C	(Note 5)	50	A
		–Continuous	T_C = 100°C	(Note 5)	32	
		–Continuous	T_A = 25°C	(Note 1a)	10.7	
		–Pulsed		(Note 4)	250	
E_{AS}	Single Pulse Avalanche Energy			(Note 3)	73	mJ
P_D	Power Dissipation		T_C = 25°C		52	W
	Power Dissipation		T_A = 25°C	(Note 1a)	2.3	
T_J, T_{STG}	Operating and Storage Junction Temperature Range				–55 to +150	°C

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

THERMAL CHARACTERISTICS

Symbol	Parameter		Ratings	Unit
$R_{\theta JC}$	Thermal Resistance, Junction to Case		2.4	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction to Ambient	(Note 1a)	53	

PACKAGE MARKING AND ORDERING INFORMATION

Device	Device Marking	Package	Reel Size	Tape Width	Quantity
NTTFS010N10MCLTAG	N10L	WDFN8 (3.3x3.3)	7”	12 mm	1500 Units

ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
OFF CHARACTERISTICS						
BV_{DSS}	Drain to Source Breakdown Voltage	I_D = 250 μA, V_{GS} = 0 V	100			V
$\frac{\Delta BV_{DSS}}{\Delta T_J}$	Breakdown Voltage Temperature Coefficient	I_D = 250 μA, referenced to 25°C		64		mV/°C
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS} = 80 V, V_{GS} = 0 V			1	μA
I_{GSS}	Gate to Source Leakage Current	V_{GS} = ±20 V, V_{DS} = 0 V			100	nA
ON CHARACTERISTICS						
$V_{GS(th)}$	Gate to Source Threshold Voltage	V_{GS} = V_{DS}, I_D = 85 μA	1.0	1.5	3.0	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate to Source Threshold Voltage Temperature Coefficient	I_D = 85 μA, referenced to 25°C		–5.3		mV/°C
$r_{DS(on)}$	Static Drain to Source On Resistance	V_{GS} = 10 V, I_D = 15 A		9.1	10.6	mΩ
		V_{GS} = 4.5 V, I_D = 12 A		13.5	15.9	
		V_{GS} = 10 V, I_D = 15 A, T_J = 125°C		15.3	17.8	
g_{FS}	Forward Transconductance	V_{DS} = 5 V, I_D = 15 A		54		S
DYNAMIC CHARACTERISTICS						
C_{ISS}	Input Capacitance	V_{DS} = 50 V, V_{GS} = 0 V, f = 1 MHz		1530	2150	pF
C_{OSS}	Output Capacitance			625	875	
C_{RSS}	Reverse Transfer Capacitance			10	18	
R_G	Gate Resistance		0.1	1.1	2.1	Ω

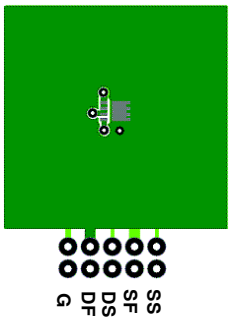
ELECTRICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted) (continued)

Symbol	Parameter	Test Conditions	Min	Typ	Max	Units
SWITCHING CHARACTERISTICS						
$t_{d(ON)}$	Turn – On Delay Time	V_{DD} = 50 V, I_D = 15 A, V_{GS} = 10 V, R_{GEN} = 6 Ω		9	19	ns
$t_{rd(ON)}$	Rise Time			3	10	
$t_{d(OFF)}$	Turn – Off Delay Time			28	45	
t_f	Fall Time			5	10	
Q_g	Total Gate Charge	V_{GS} = 0V to 10 V; V_{DD} = 50 V, I_D = 15 A		22	30	nC
Q_g	Total Gate Charge	V_{GS} = 0V to 4.5 V; V_{DD} = 50 V, I_D = 15 A		10		
Q_{gs}	Gate to Source Charge	V_{DD} = 50 V, I_D = 15 A		4		
Q_{gd}	Gate to Drain “Miller” Charge	V_{DD} = 50 V, I_D = 15 A		3		
Q_{oss}	Output Charge	V_{DD} = 50 V, V_{GS} = 0 V		41		nC
Q_{sync}	Total Gate Charge Sync	V_{DS} = 0 V, V_{GS} = 0 to 10 V		19		
DRAIN–SOURCE DIODE CHARACTERISTICS						
V_{SD}	Source to Drain Diode Forward Voltage	V_{GS} = 0 V, I_S = 2 A (Note 2)		0.7	1.2	V
		V_{GS} = 0 V, I_S = 15 A (Note 2)		0.8	1.3	
t_{rr}	Reverse Recovery Time	I_F = 8 A, di/dt = 300 A/μs		22	36	ns
Q_{rr}	Reverse Recovery Charge			35	56	nC
t_{rr}	Reverse Recovery Time	I_F = 8 A, di/dt = 1000 A/μs		17	30	ns
Q_{rr}	Reverse Recovery Charge			79	126	nC

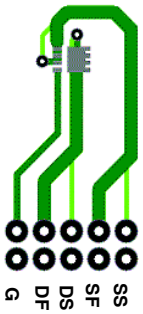
Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

NOTES:

1. $R_{\theta JA}$ is determined with the device mounted on a 1 in^2 pad 2 oz copper pad on a 1.5 × 1.5 in. board of FR–4 material. $R_{\theta CA}$ is determined by the user’s board design.



a) 53°C/W when mounted on a 1 in^2 pad of 2 oz copper.



b) 125°C/W when mounted on a minimum pad of 2 oz copper.

2. Pulse Test: Pulse Width < 300 μs, Duty cycle < 2.0%.
3. E_{AS} of 73 mJ is based on starting T_J = 25°C; L = 3 mH, I_{AS} = 7 A, V_{DD} = 100 V, V_{GS} = 10 V. 100% test at L = 0.5 mH, I_{AS} = 13 A.
4. Pulsed I_D please refer to Figure 11 SOA graph for more details.
5. Computed continuous current limited to Max Junction Temperature only, actual continuous current will be limited by thermal & electro–mechanical application board design.

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

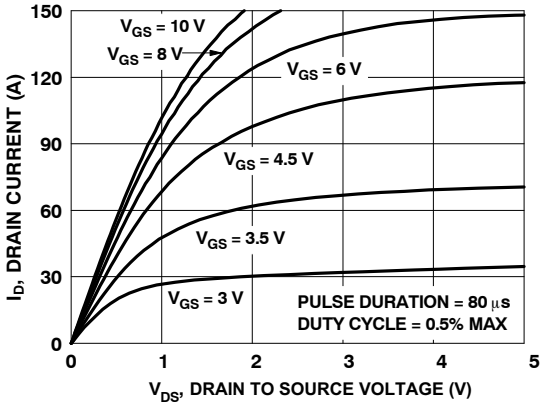


Figure 1. On Region Characteristics

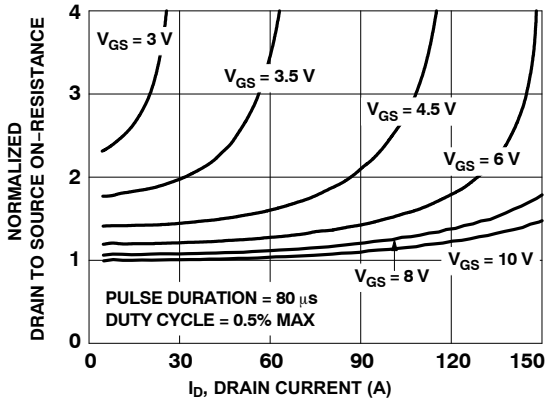


Figure 2. Normalized On−Resistance vs. Drain Current and Gate Voltage

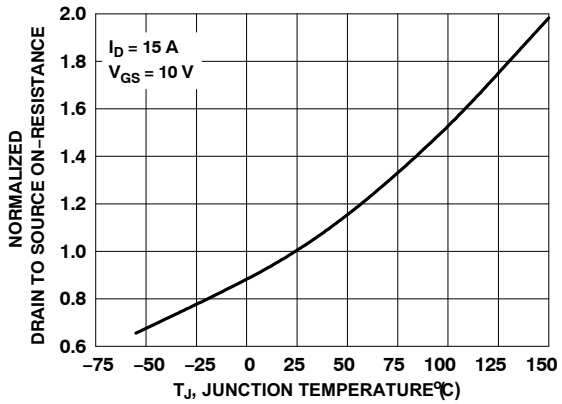


Figure 3. Normalized On Resistance vs. Junction Temperature

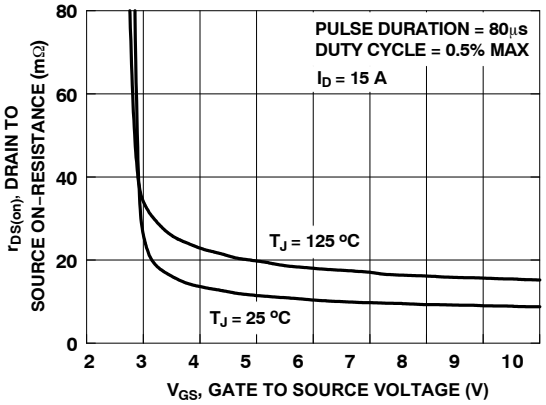


Figure 4. On-Resistance vs. Gate to Source Voltage

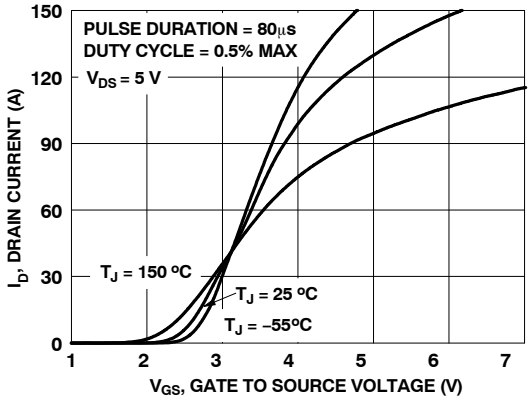


Figure 5. Transfer Characteristics

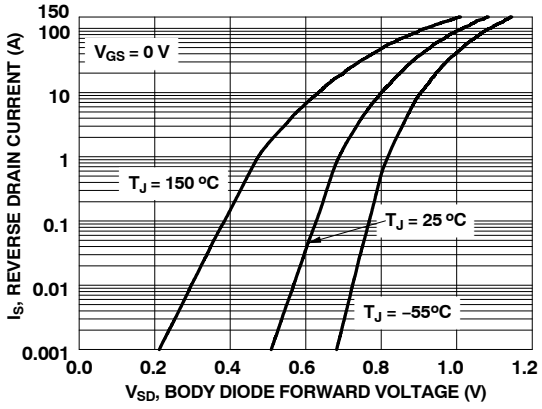


Figure 6. Source to Drain Diode Forward Voltage vs. Source Current

TYPICAL CHARACTERISTICS (T_J = 25°C unless otherwise noted)

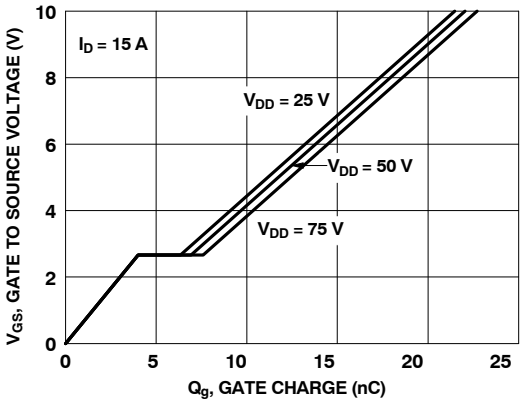


Figure 7. Gate Charge Characteristics

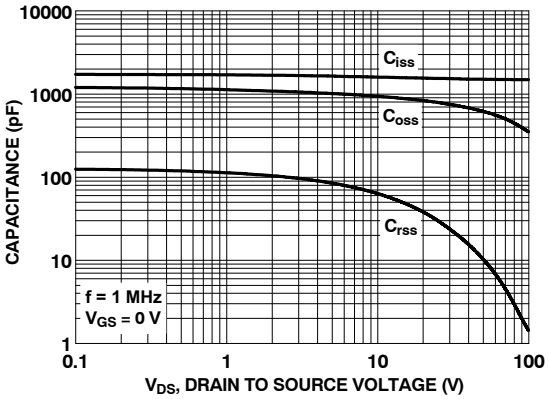


Figure 8. Capacitance vs. Drain to Source Voltage

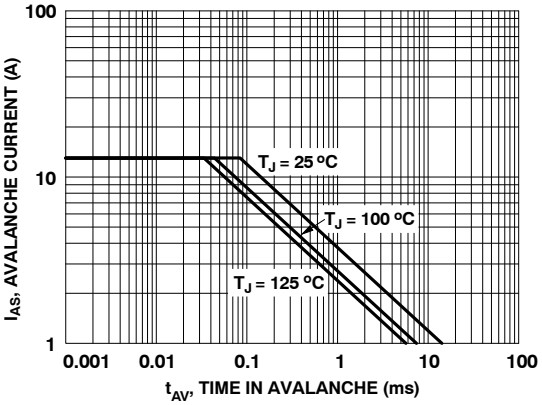


Figure 9. Unclamped Inductive Switching Capability

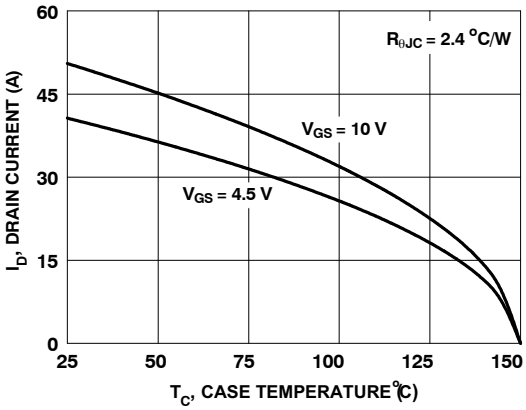


Figure 10. Maximum Continuous Drain Current vs. Case Temperature

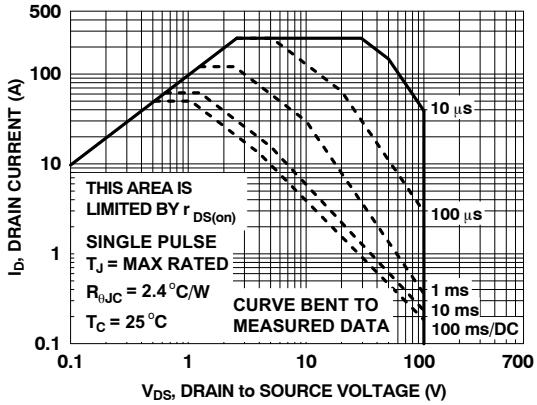


Figure 11. Forward Bias Safe Operating Area

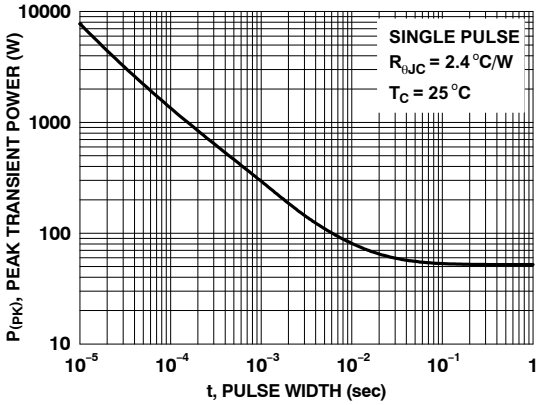


Figure 12. Single Pulse Maximum Power Dissipation

TYPICAL CHARACTERISTICS (continued)

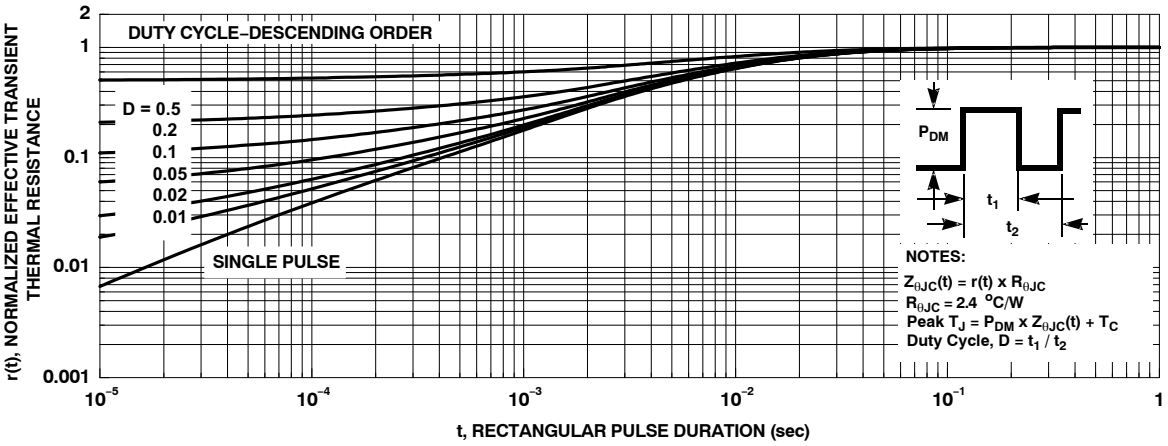
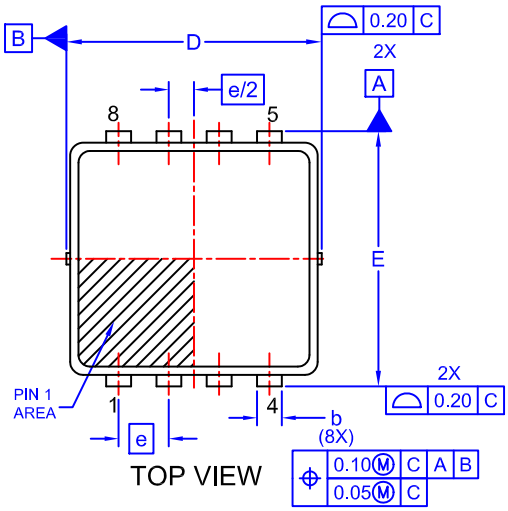


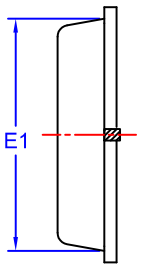
Figure 13. Junction−to−Case Transient Thermal Response Curve

WDFN8 3.3x3.3, 0.65P
CASE 511DY
ISSUE A

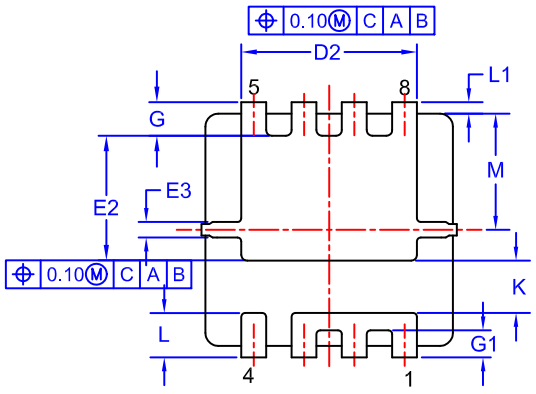
DATE 21 AUG 2018



TOP VIEW

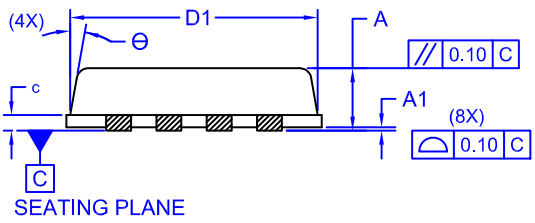


SIDE VIEW

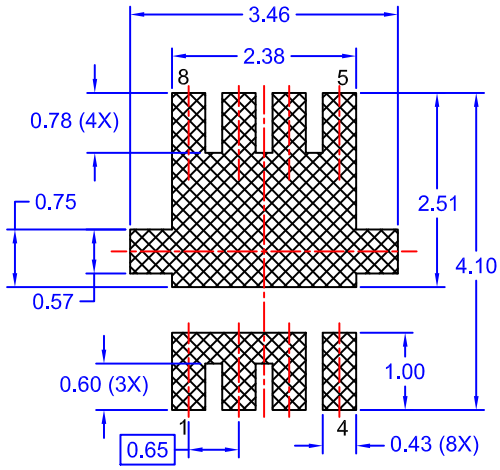


BOTTOM VIEW

NOTES:
1. CONTROLLING DIMENSION: MILLIMETERS
2. DIMENSIONS D1 & E1 DO NOT INCLUDE MOLD FLASH PROTRUSIONS NOR GATE BURRS.



END VIEW



RECOMMENDED LAND PATTERN

DIM	MILLIMETERS		
	MIN	NOM	MAX
A	0.70	0.75	0.80
A1	0.00	-	0.05
b	0.23	0.33	0.43
c	0.15	0.20	0.25
D	3.20	3.30	3.40
D1	2.95	3.13	3.30
D2	1.98	2.20	2.40
E	3.20	3.30	3.40
E1	2.80	3.00	3.15
E2	1.40	1.60	1.80
E3	0.15	0.25	0.40
e	0.65 BSC		
G	0.30	0.43	0.55
G1	0.25	0.35	0.45
K	0.55	0.75	0.95
L	0.35	0.52	0.65
L1	0.06	0.15	0.30
M	1.35	1.50	1.60
Θ	0	-	12

GENERIC MARKING DIAGRAM*



XXXX = Specific Device Code
A = Assembly Location
Y = Year Code
WW = Work Week Code

*This information is generic. Please refer to device data sheet for actual part marking. Pb−Free indicator, “G” or microdot “ ▪”, may or may not be present. Some products may not follow the Generic Marking.

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DESCRIPTION:	**WDFN8 3.3x3.3, 0.65P**	**PAGE 1 OF 1**

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Üretici parça numarasını yazın; stok ve fiyatı hemen görün.

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Kategorilere göz atın

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Toplu alım ve teklif

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